



Product Change Notice

Micron PCN: 30998
 Date: 9/12/2013

Type of Change:	End of Life	
Title of Change:	EOL 25nm 4GB and 8GB eMMC JEDEC 4.41 - WFBGA 153b 11.5 x13x0.8 mm	
Description of Change:	Micron 25nm 4GB and 8GB eMMC JEDEC 4.41- WFBGA 153b 11.5 x13x0.8 mm products are being discontinued	
Reason for Change:	Product portfolio optimization and market trend adaptation	
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Product Affected: 25nm 4GB and 8GB eMMC JEDEC 4.41 - WFBGA 153b 11.5 x13x0.8

Affected Micron Part Numbers	Suggested Replacement Part Numbers
MTFC4GMTEA-WT	MTFC4GACAAEA-WT (20nm 4GB eMMC JEDEC 4.51 WFBGA 153b 11.5 x13x0.8)
MTFC4GMUEA-WT	
MTFC4GMXEA-WT	
MTFC8GLTEA-WT	MTFC8GACAAEA-WT (20nm 8GB eMMC JEDEC 4.51 WFBGA 153b 11.5 x13x0.8)
MTFC8GLXEA-WT	

Micron Sites Affected: All Sites

Schedule for MPNs being discontinued:

Last Buy Date: 28-Feb-2014 (*)
Last Ship Date: 31-Aug-2014

Schedule for Suggested Replacement:

Sample Available: 31-Oct-2013
Qual Data Available: 15-Jan-2014
Product Ship Date: 30-Jan-2014

* Orders placed prior to the LTB date are subject to current inventory levels, which may vary based on market conditions and customer demand. Early orders are encouraged.

Note: Per JEDEC Standard JESD46-C Section 3.2.3; lack of acknowledgment of this PCN within 30 days constitutes acceptance of change